

FDP054N10 N-Channel PowerTrench[®] MOSFET 100 V, 144 A, 5.5 m Ω

Features

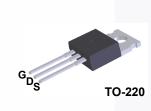
- $R_{DS(on)}$ = 4.6 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 75 A
- · Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

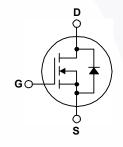
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Micro Solar Inverter





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FDP054N10	Unit		
V _{DSS}	Drain to Source Voltage		100	V	
V _{GSS}	Gate to Source Voltage		±20	V	
ID		- Continuous (T _C = 25 ^o C, Silicon Limited)	144		
	Drain Current	- Continuous (T _C = 100 ^o C, Silicon Limited)) 102	A	
		- Continuous (T _C = 25°C, Package Limited	d) 120		
I _{DM}	Drain Current	- Pulsed (Note	1) 576	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		2) 1153	mJ	
dv/dt	Peak Diode Avalanche Energy (Note 3)		3) 6	V/ns	
P _D	Dower Dissinction	(T _C = 25 ^o C)	263	W	
	Power Dissipation	- Derate Above 25°C	1.75	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

Thermal Characteristics

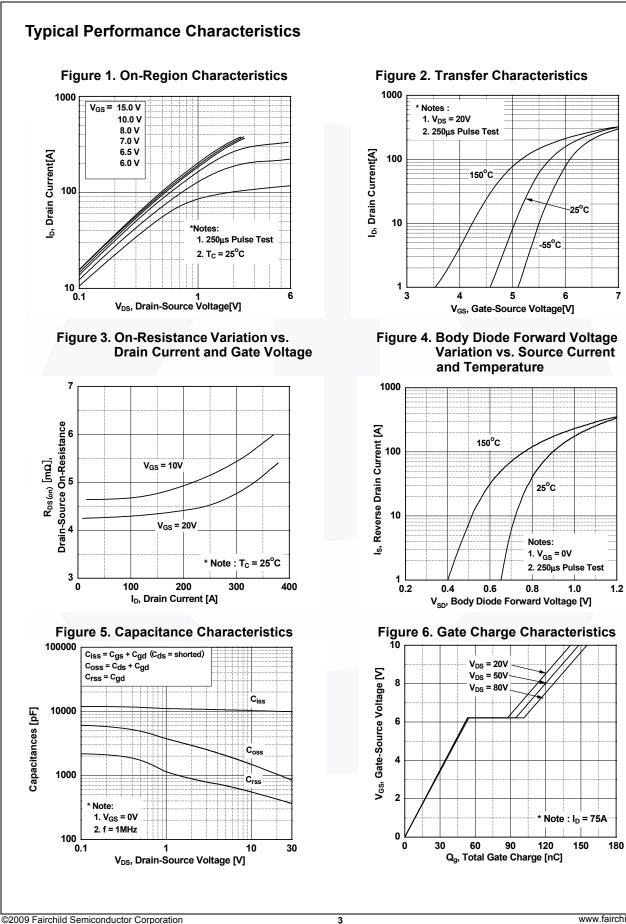
Symbol	Parameter	FDP054N10	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.57	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/vv

November 2013

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			Packag	ge Packing Method	Reel Size	Тар	e Width	Qua	ntity
Electrical			TO-22			N/A		50 units	
	Chara	acteristics T _C = 2	5ºC unless	otherwise noted.					
Symbol		Parameter		Test Conditio	ons	Min.	Тур.	Max.	Unit
Off Charact	teristics	5							
BV _{DSS}	Drain to Source Breakdown Voltage		age	I _D = 250 μA, V _{GS} = 0 V, T _C = 25 ^o C			-	-	V
ΔΒV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		3	$I_D = 250 \ \mu$ A, Referenced to 25° C		-	0.01	-	V/ºC
I _{DSS}	Zero Gat	te Voltage Drain Curren	t	$V_{DS} = 100 V, V_{GS} = 0 V$ $V_{DS} = 100 V, V_{GS} = 0 V, T_C = 150^{\circ}C$			-	1 500	μA
I _{GSS}	Gate to F	Body Leakage Current		V_{GS} = ±20 V, V_{DS} = 0 V	,	-	-	±100	nA
On Charact	eristics								
V _{GS(th)}	-	reshold Voltage		V _{GS} = V _{DS} , I _D = 250 μA		2.5	3.5	4.5	V
R _{DS(on)}		ain to Source On Resist	tance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 75 \text{ A}$		-	4.6	5.5	mΩ
9FS		Transconductance		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 75 \text{ A}$		-	192	-	S
Dynamic Cl	haracte	ristics							
C _{iss}	1	pacitance					9985	13280	pF
C _{oss}		Capacitance		$V_{\rm DS}$ = 25 V, $V_{\rm GS}$ = 0 V,		-	935	1245	pF
C _{rss}	-	Transfer Capacitance		f = 1 MHz		-	390	585	pF
Q _{g(tot)}		te Charge at 10V		V _{DS} = 80 V, I _D = 75 A,		-	156	203	nC
Q _{gs}	Gate to S	Source Gate Charge		$V_{GS} = 10 V$		-	53	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			(Note 4)			48	-	nC
	Charact	oriotico							
Switching (1
t _{d(on)}		Delay Time		$V_{DD} = 50 V, I_D = 75 A,$ $V_{GS} = 10 V, R_G = 4.7 Ω$		-	44	98	ns
t _r		Rise Time				•	92	194	ns
t _{d(off)}		Delay Time Fall Time					80 39	170 88	ns
t _f	Turn-On				(Note 4)	-	- 39	00	ns
Drain-Sour	ce Diod	e Characteristics							
I _S	Maximum	n Continuous Drain to S	ource Diod	le Forward Current		-	-	144	Α
I _{SM}	Maximum	n Pulsed Drain to Sourc	e Diode Fo	Forward Current			-	576	Α
V _{SD}	Drain to \$	Source Diode Forward \	/oltage	V _{GS} = 0 V, I _{SD} = 75 A		-	-	1.3	V
t _{rr}		Recovery Time		V _{GS} = 0 V, I _{SD} = 75 A,		-	57	-	ns
Q _{rr}	Reverse	Recovery Charge		dI _F /dt = 100 A/μs		-	121	-	nC

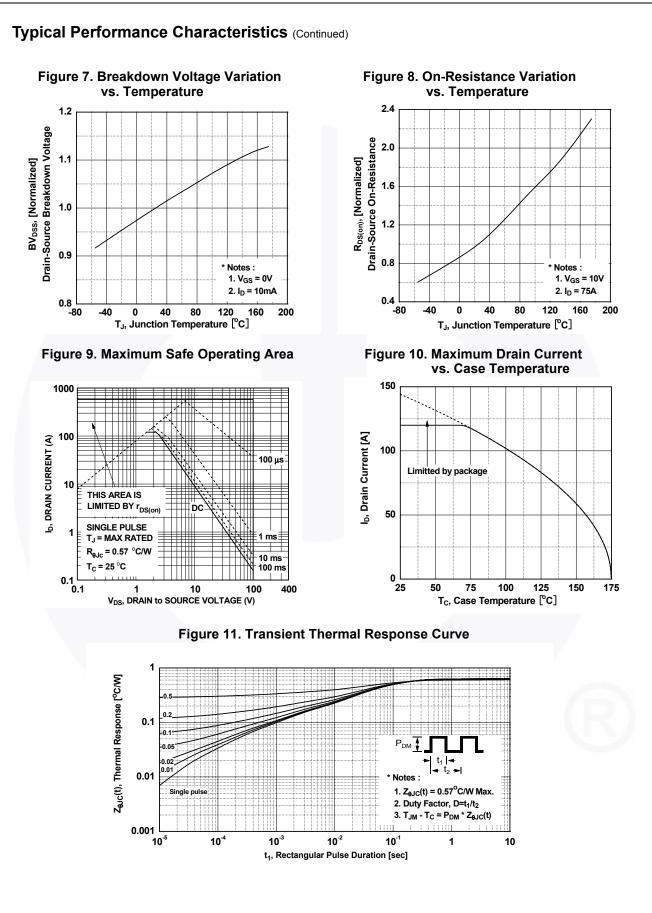
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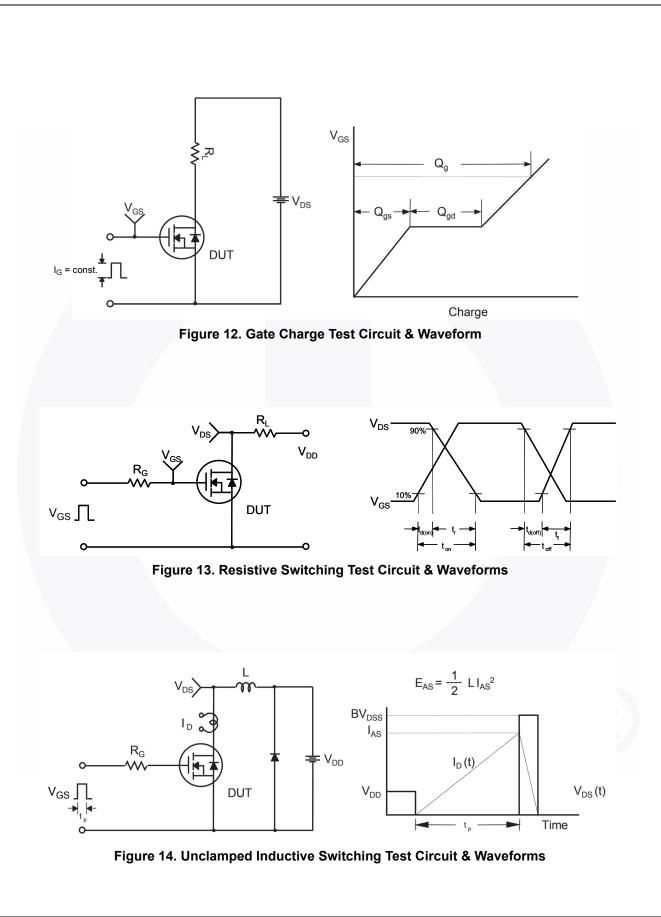
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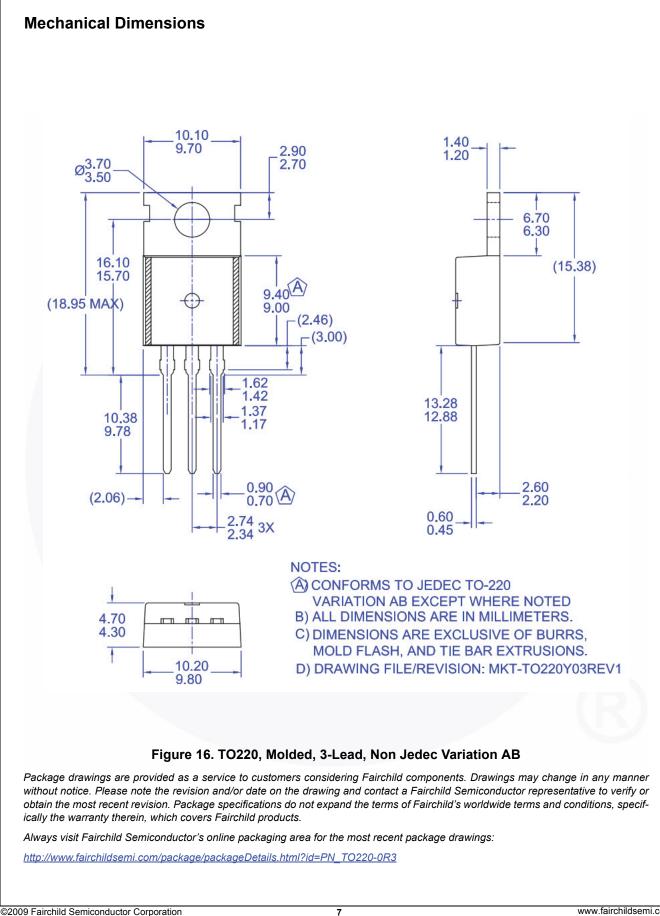


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DUT + v_{DS} a ۱_{SD} م L Driver R_G, Same Type as DUT L F ∨_{DD} $\prod V_{GS}$ • dv/dt controlled by R_G • I_{SD} controlled by pulse period Î Gate Pulse Width V_{GS} D = Gate Pulse Period 10V (Driver) I_{FM}, Body Diode Forward Current I _{SD} di/dt (DUT) I_{RM} Body Diode Reverse Current V_{DS} (DUT) Body Diode Recovery dv/dt V_{SD} V_{DD} Body Diode Forward Voltage Drop Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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